T2020012005-000 ACTIVE



HDC | HDC HDD

TE Internal #: T2020012005-000

Gold (Au), Socket Contact, 20 AWG, .5 mm² Wire, Discrete Wire,

Crimp, Brass, Power & Signal, HDC HDD

View on TE.com >



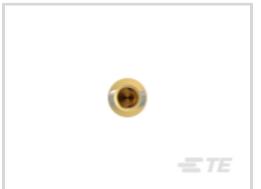
Connectors > Contacts > Connector Contacts











Contact Type: Socket

Contact Mating Area Plating Material: Gold (Au)

Wire Contact Termination Area Plating Material: Gold Compatible With Wire & Cable Type: Discrete Wire

Wire Size: 20 AWG

Features

Product Type Features

Discrete Wire Type	Solid or Stranded
Sealable	No

Configuration Features

Compatible With Wire & Cable Type	Discrete Wire

Electrical Characteristics

Contact Resistance	$5~\mathrm{m}\Omega$	

Contact Features

Contact reatures	
Contact Shape & Form	Round
Contact Type	Socket
Contact Mating Area Plating Material	Gold (Au)
Wire Contact Termination Area Plating Material	Gold
Contact Base Material	Brass
Contact Current Rating (Max)	10 A
Contact Mating Area Plating Material Finish	Bright



Termination Features

Termination Method to Wire & Cable	Crimp		
Product Terminates To	Wire & Cable		
Dimensions			
Wire Size	.5 mm ²		
Operation/Application			
Compatible With Wire Base Material	Copper		
Circuit Application	Power & Signal		

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant with Exemptions
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	有害物质含量超出标准 Restricted Substance(s) Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JUNE 2025 (250) SVHC > Threshold: Pb (3.7% in 74018819) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

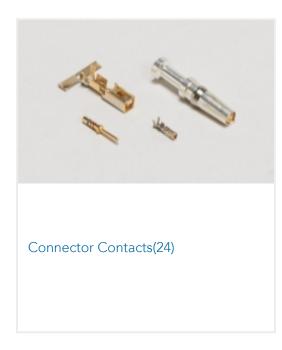


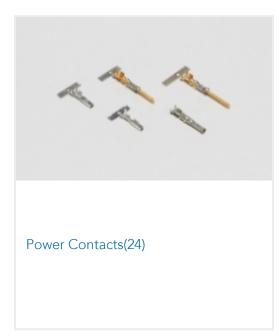
Compatible Parts

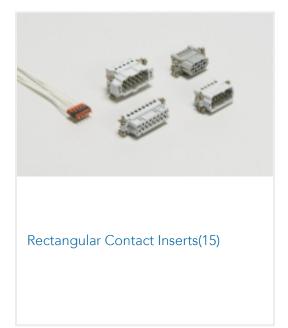




Also in the Series | HDC HDD







Customers Also Bought















Documents

Product Drawings DDF-0.5

English

CAD Files



3D PDF

3D

Customer View Model

ENG_CVM_CVM_T2020012005-000_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_T2020012005-000_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_T2020012005-000_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Heavy Duty Connectors

English

HEAVY DUTY CONNECTORS

English

HEAVY DUTY CONNECTORS

Japanese

Product Specifications

Application Specification

English